

Features

- Current-controlled Output Current Source, 3 Input Channels
- Two Selectable Outputs for Grounded Laser Diodes
- Output Current per Channel up to 250 mA
- Total Output Current to 300 mA (Minimum)
- Rise Time 1.0 ns, Fall Time 1.1 ns
- On-chip RF Oscillator
- Control of 2 Different Swings by Use of 2 external Resistors
- Oscillator Frequency Range from 200 MHz to 600 MHz
- Oscillator Swing to 100 mA
- Single 5V Power Supply
- Common Enable/Disable Input
- TTL/CMOS Control Signals
- Small PB-free QFN16 (4 mm × 4 mm) or SSO16 Package

Applications

- DVD-ROM with CD-RW Capability (Combo Drives)
- Combo Drives with CD and DVD Writing Capability

1. Description

The T0806 is a laser diode driver for the operation of two different grounded laser diodes for DVD-RAM (650 nm) and CD-RW (780 nm) drives. It includes three channels for three different optical power levels which are controlled by a separate IC. The read channel generates a continuous output level whereas channels 2 and 3 are provided as write channels with very fast switching speeds. Write current pulses are enabled when a low signal is applied to the NE pins. All channels are summed together and switched to one of the two outputs IOUTA or IOUTB by the select input SELA. Each channel can contribute up to 250 mA to the total output current of up to 300 mA. A total gain of 100 is provided between each reference current input and the selected output. Although the reference inputs are current inputs, voltage control is possible by using external resistors.

An on-chip RF oscillator is provided to reduce laser mode hopping noise during read mode. Swing can be set independently for the two selectable outputs with two different resistors. Oscillation is enabled by a high signal at the ENOSC pin. Complete output current and oscillator switch-off is achieved by a low signal at the ENABLE input.



3-channel Laser Driver with RF Oscillator and 2 Outputs

T0806

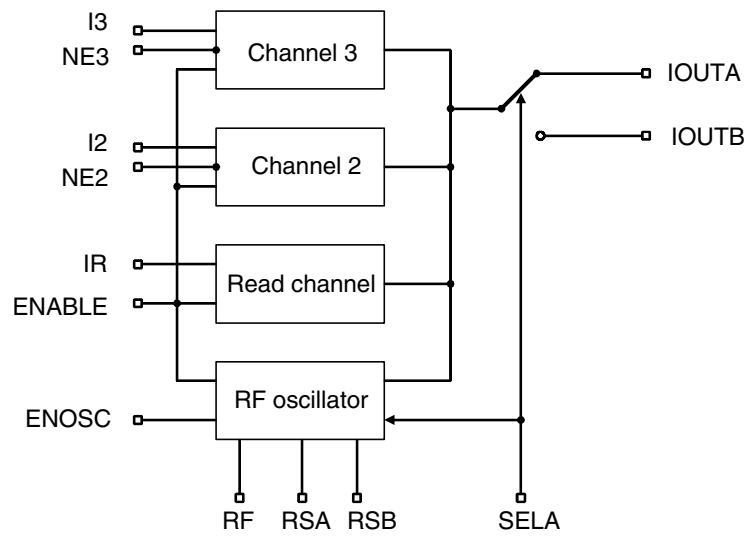
Summary

Rev. 4522FS–DVD–11/05



Note: This is a summary document. A complete document is available under NDA. For more information, please contact your local Atmel sales office.

Figure 1-1. Block Diagram



2. Pin Configuration

Figure 2-1. Pinning SSO16

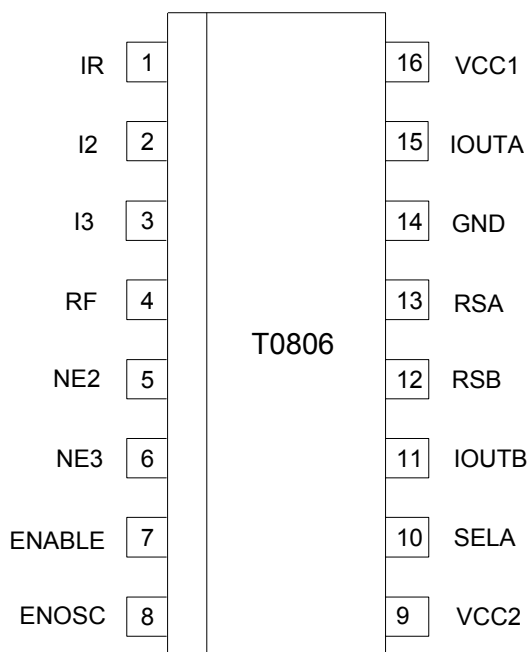


Table 2-1. Pin Description SSO16

Pin	Symbol	Type	Function
1	IR	Analog	Input current, bias voltage approximately GND
2	I2	Analog	Input current, bias voltage approximately GND
3	I3	Analog	Input current, bias voltage approximately GND
4	RF	Analog	External resistor to GND sets oscillator frequency of oscillator A
5	NE2	Digital	Digital control of channel 2 (low active)
6	NE3	Digital	Digital control of channel 3 (low active)
7	ENABLE	Digital	Enables output current (high active)
8	ENOSC	Digital	Enables RF oscillator (high active)
9	VCC2	Supply	+5V power supply for IOUT
10	SELA	Digital	High: selects IOUTA, RSA Low: selects IOUTB, RSB
11	IOUTB	Analog	Output current source B for laser diode
12	RSB	Analog	External resistor to GND sets swing of oscillator B
13	RSA	Analog	External resistor to GND sets swing of oscillator A
14	GND	Supply	Ground
15	IOUTA	Analog	Output current source A for laser diode
16	VCC1	Supply	+5V power supply for IOUT and circuit

Figure 2-2. Pinning QFN16

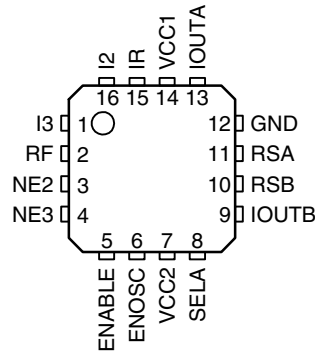


Table 2-2. Pin Description QFN16

Pin	Symbol	Type	Function
1	I3	Analog	Input current, bias voltage approximately GND
2	RF	Analog	External resistor to GND sets oscillator frequency
3	NE2	Digital	Digital control of channel 2 (low active)
4	NE3	Digital	Digital control of channel 3 (low active)
5	ENABLE	Digital	Enables output current (high active)
6	ENOSC	Digital	Enables RF oscillator (high active)
7	VCC2	Supply	+5V power supply for IOUT
8	SELA	Digital	High: selects IOUTA, RSA Low: selects IOUTB, RSB
9	IOUTB	Analog	Output current source B for laser diode
10	RSB	Analog	External resistor to GND sets swing of oscillator B
11	RSA	Analog	External resistor to GND sets swing of oscillator A
12	GND	Supply	Ground
13	IOUTA	Analog	Output current source A for laser diode
14	VCC1	Supply	+5V power supply for IOUT and circuit
15	IR	Analog	Input current, bias voltage approximately GND
16	I2	Analog	Input current, bias voltage approximately GND
Paddle	GND	Supply	Ground

3. Absolute Maximum Ratings

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Parameters	Symbol	Value	Unit
Supply voltage	V_{CC}	–0.5 to +6.0	V
Input voltage at IR, I2, I3	V_{IN1}	–0.5 to +1.0	V
Input voltage at NE2, NE3, ENOSC	V_{IN2}	–0.5 to $V_{CC} + 0.5$	V
Output voltage	V_{OUT}	–0.5 to $V_{CC} - 1$	V
Total output current	I_{OUT}	350	mA
Output current per channel	I_{OUT} (IR, I2, I3)	300	mA
Power dissipation	P_{MAX}	0.7 ⁽¹⁾ to 1 ⁽²⁾	W
Junction temperature	T_J	150	°C
Storage temperature range	T_{Stg}	–65 to +125	°C

Notes: 1. $R_{thJA} \leq 115 \text{ K/W}$, $T_{amb} = 70^\circ \text{C}$

2. $R_{thJA} \leq 115 \text{ K/W}$, $T_{amb} = 25^\circ \text{C}$

4. Thermal Resistance

Parameters	Symbol	Value	Unit
Junction ambient	R_{thJA}	135	K/W

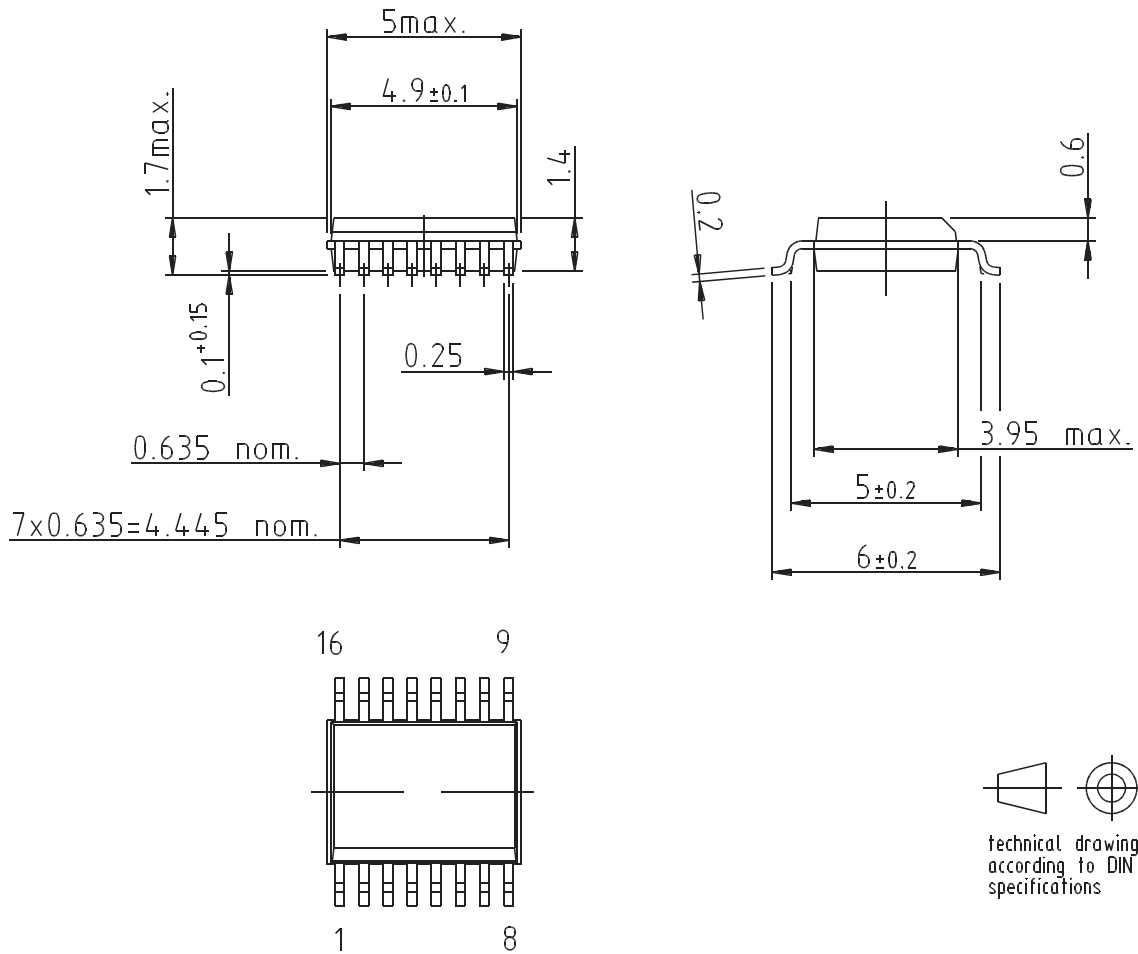
5. Recommended Operating Conditions

Parameters	Symbol	Value	Unit
Supply voltage range	V_{CC}	4.5 to 5.5	V
Input current	$I_{IR}/I_{I2}/I_{I3}$	< 3.0	mA
External resistor to GND to set oscillator frequency	RF	> 3	k Ω
External resistor to GND to set oscillator swing	RSA, RSB	> 1	k Ω
Operating temperature range	T_{amb}	0 to +70	°C

6. Ordering Information

Extended Type Number	Package	Remarks
T0806-TCQG	SSO16	Taped and reeled, Pb-free
T0806-PEQG	Pb-free QFN16 (4 mm × 4 mm)	Taped and reeled, Pb-free

7. Package Information

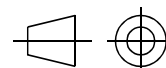
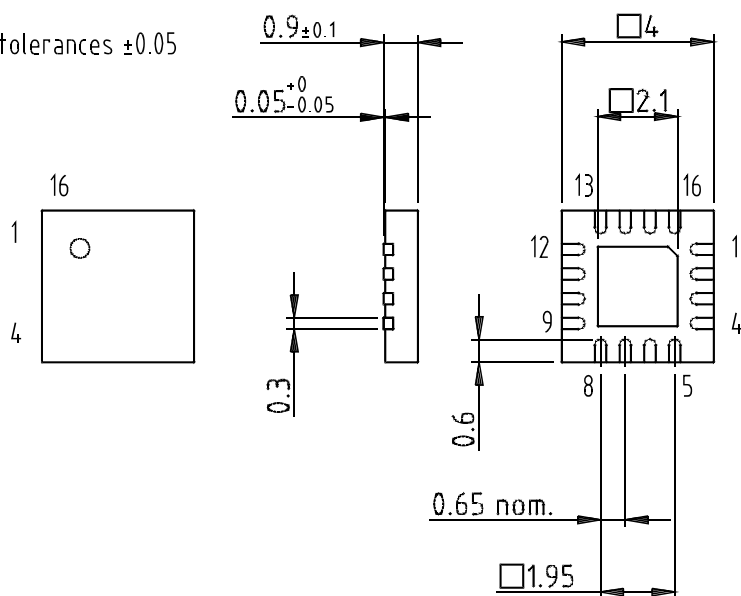


Drawing refers to following types: SS016
Package acc. JEDEC MO 137 AB

Drawing-No.: 6.543-5060.01-4
Issue: 2; 05.02.99

Package: QFN 16 - 4x4
 Exposed pad 2.1x2.1
 (acc. JEDEC OUTLINE No. MO-220)
 Dimensions in mm

Not indicated tolerances ± 0.05



technical drawings
 according to DIN
 specifications

Drawing-No.: 6.543-5090.01-4

Issue: 2; 24.01.03



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